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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





January 2008

## FPF2500-FPF2506 IntelliMAX<sup>™</sup> Advanced Load Management Products

#### Features

- 4.5 to 20V Input Voltage Range
- Controlled Turn-On
- 0.4A, 0.8A and Adjustable Current Limit Option
- Undervoltage Lockout
- Thermal Shutdown
- <10µA Shutdown Current</p>
- Auto Restart
- Fault Blanking
- RoHS Compliant

## Applications

- PDAs
- Motor Drivers
- Cell Phones
- Digital Cameras



## **General Description**

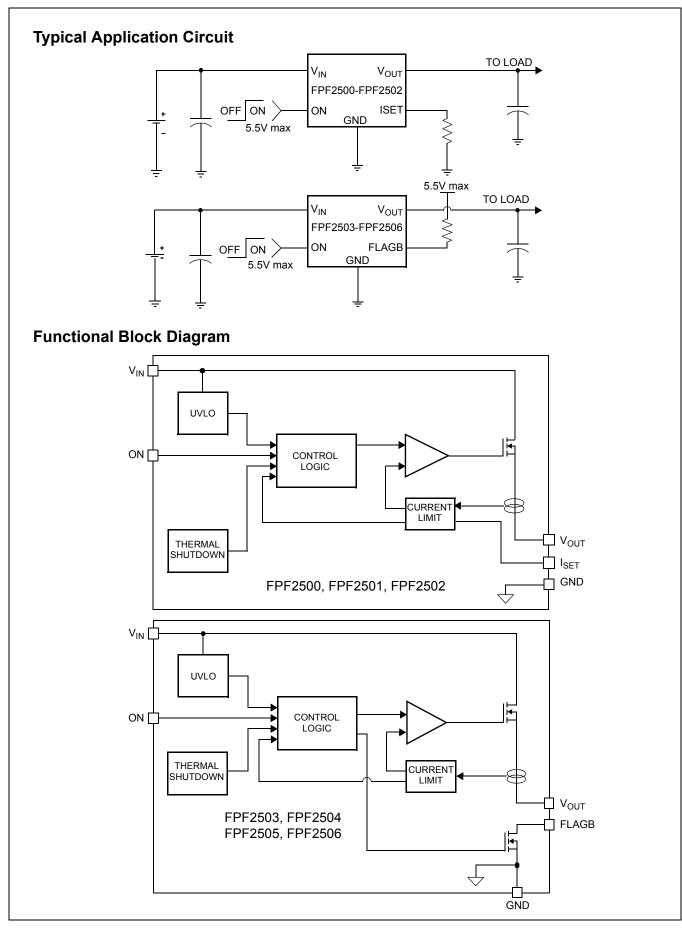
The FPF2500 through FPF2506 is a family of load switches which provide full protection to systems and loads which may encounter large current conditions. These devices contain a  $0.23\Omega$  current-limited N-channel MOSFET which can operate over an input voltage range of 4.5-20V. Switch control is by a logic input (ON) capable of interfacing directly with low voltage control signals. Each part contains thermal shutdown protection which shuts off the switch to prevent damage to the part when a continuous over-current condition causes excessive heating.

When the switch current reaches the current limit, the part operates in a constant-current mode to prohibit excessive currents from causing damage. For the FPF2500, FPF2501, FPF2503 and FPF2505, if the constant current condition still persists after 5ms, these parts will shut off the switch and, for the FPF2503 and FPF2505, the fault signal pin (FLAGB) will be pulled low. The FPF2500, FPF2503, and FPF2505, have an auto-restart feature which will turn the switch on again after 640ms if the ON pin is still active. The FPF2501 does not have this auto-restart feature so the switch will remain off until the ON pin is cycled. For the FPF2502, FPF2504 and FPF2506, a current limit condition will immediately pull the fault signal pin low and the part will remain in the constant-current mode until the switch current falls below the current limit. For the FPF2500 through FPF2502, the minimum current limit is adjustable from 500mA to 2A. For the FPF2503 and FPF2504 the minimum current is internally fixed at 400mA while that for the FPF2505 and FPF2506 is internally fixed at 800mA.

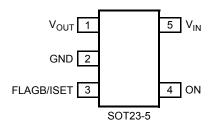
These parts are available in a space-saving 5 pin SOT23 package.

## **Ordering Information**

Part	Current Limit [A]	Current Limit Blanking Time [ms]	Auto-Restart Time [ms]	Fault Pin
FPF2500	Adjustable (0.5-2.0 +/-30%)	2.5/5/10	320/640/1280	No
FPF2501	Adjustable (0.5-2.0 +/-30%)	2.5/5/10	NA	No
FPF2502	Adjustable (0.5-2.0 +/-30%)	0	NA	No
FPF2503	0.4/0.6/0.8	2.5/5/10	320/640/1280	Yes
FPF2504	0.4/0.6/0.8	0	NA	Yes
FPF2505	0.8/1.2/1.6	2.5/5/10	320/640/1280	Yes
FPF2506	0.8/1.2/1.6	0	NA	Yes



## **Pin Configuration**



## **Pin Description**

Pin	Name	Function
1	V <sub>OUT</sub>	Switch Output: Output of the power switch
2	GND	Ground
3	FLAGB	Fault Output (FPF2503-FPF2506): Active LO, open drain output which indicates on over current supply under voltage or over temperature state.
3	ISET	Adjustable Current Limit Setting Resistor (FPF2500-FPF2502): An external resistor connected between this pin and ground sets the current limit value.
4	ON	ON Control Input:
5	V <sub>IN</sub>	Supply Input: Input to the power switch and the supply voltage for the IC

## **Absolute Maximum Ratings**

Parameter		Min	Max	Unit
V <sub>IN</sub> , V <sub>OUT</sub> , to GND		-0.3	20	V
ON, FLAGB, ISET to GND		-0.3	5.5	V
Power Dissipation @ T <sub>A</sub> =25°C (Note 1)			667	mW
Operating Temperature Range		-40	125	°C
Storage Temperature		-65	150	°C
Thermal Resistance, Junction to Ambient			150	°C/W
Electrostatic Discharge Protection	HBM	2000		V
	MM	200		V

## **Recommended Operating Range**

Parameter	Min	Мах	Unit
V <sub>IN</sub>	4.5	20	V
Ambient Operating Temperature, T <sub>A</sub>	-40	85	٦°

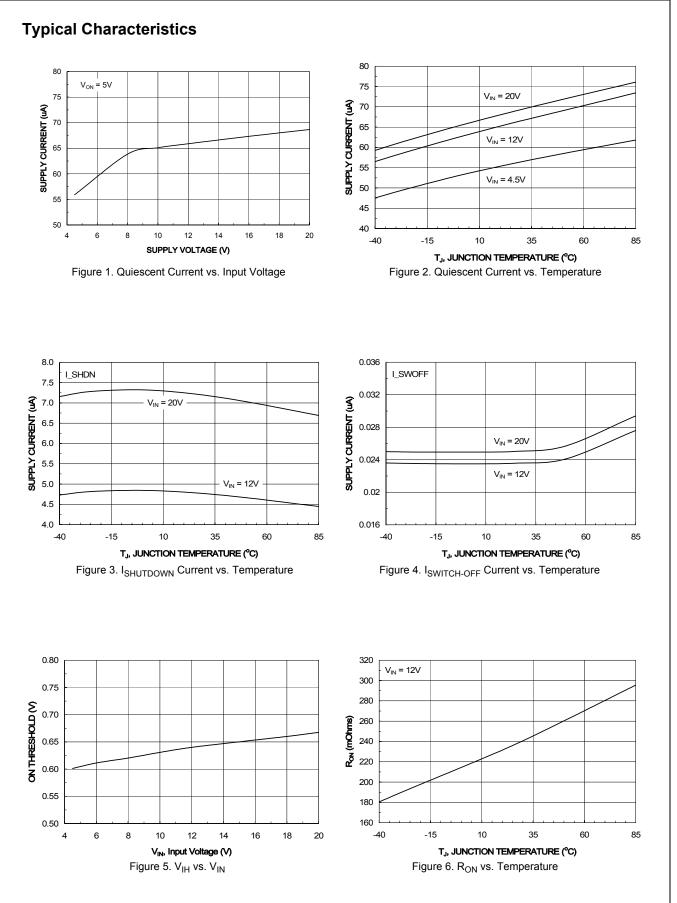
## **Electrical Characteristics**

 $V_{IN}$  = 4.5 to 20V,  $T_A$  = -40 to +85°C unless otherwise noted. Typical values are at  $V_{IN}$  = 12V and  $T_A$  = 25°C.

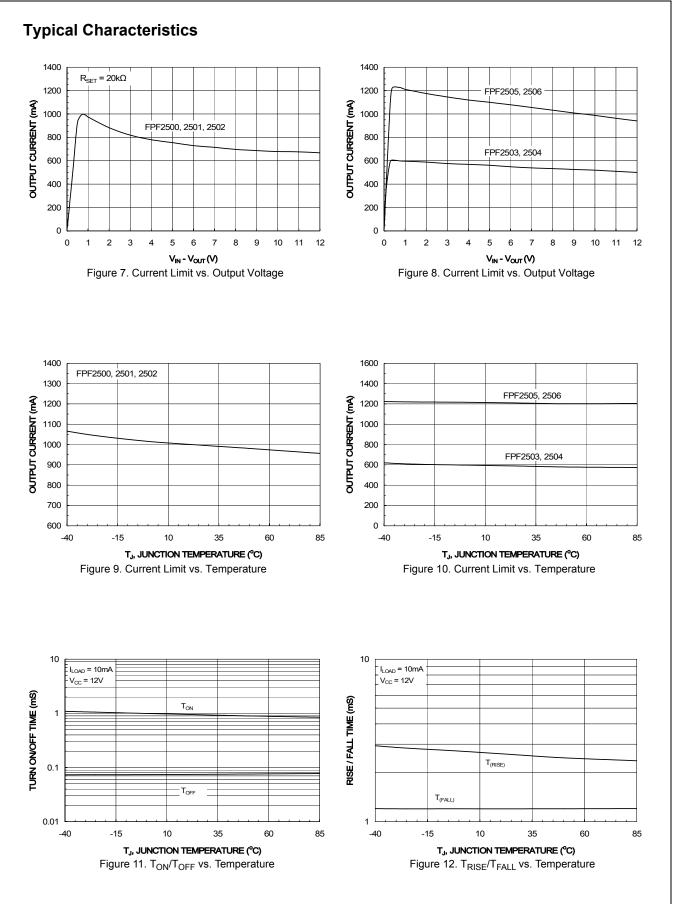
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Basic Operation						
Operating Voltage	V <sub>IN</sub>		4.5		20	V
Quiescent Current	ا <sub>Q</sub>	I <sub>OUT</sub> = 0mA, V <sub>IN</sub> = 12V, Von=5V		60	100	μA
Shutdown Current	I <sub>SHDN</sub>				1	μA
Latch-Off Current	ILATCHOFF	FPF2501		45		μA
		V <sub>IN</sub> = 12V, I <sub>OUT</sub> = 50mA, T <sub>A</sub> = 25°C		230	320	
On-Resistance	R <sub>ON</sub>	V <sub>IN</sub> = 12V, I <sub>OUT</sub> = 50mA, T <sub>A</sub> = 85°C		300	400	mΩ
		V <sub>IN</sub> = 12V, I <sub>OUT</sub> = 50mA, T <sub>A</sub> = -40°C to +85°C	110		400	

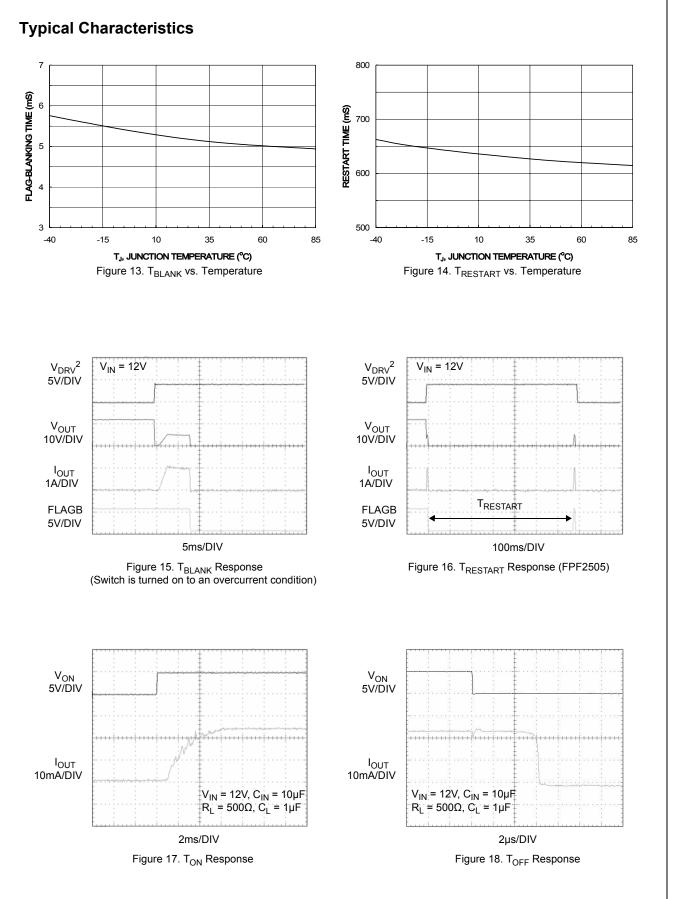
Parameter	Symbol	Co	onditions	Min	Тур	Max	Unit
ON Input Logic High Voltage	V <sub>IH</sub>	V <sub>IN</sub> = 4.5V to 2	0V	0.9			V
ON Input Logic Low Voltage	V <sub>IL</sub>	V <sub>IN</sub> = 4.5V to 2	0V			0.4	V
ON Input Leakage		V <sub>ON</sub> = 5V or G	ND	-1		1	μA
		$V_{ON} = 0V, V_{OU}$	<sub>r</sub> = 0V @ V <sub>IN</sub> = 12V			1	μA
Off Switch Leakage	I <sub>SWOFF</sub>	$V_{ON} = 0V, V_{OUT} = 0V$ @ $V_{IN} = 12V, T_A = 25^{\circ}C$			30	100	nA
FLAGB Output Logic Low Voltage		V <sub>IN</sub> = 5V, I <sub>SINK</sub>	= 10mA		0.1	0.2	V
FLAGB Output High Leakage Current		V <sub>IN</sub> = 5V, Switc	h on			1	μA
Protections							
	I <sub>LIM</sub>	T <sub>A</sub> =25 °C	FPF2503, FPF2504	400	600	800	mA
Current Limit			FPF2505, FPF2506	800	1200	1600	
			FPF2500, FPF2501 FPF2502	0.7xI <sub>NOM</sub>	1.0xI <sub>NOM</sub>	1.3xI <sub>NOM</sub>	
Thermal Shutdown		T <sub>J</sub> Increasing			140		°C
mermai Shudown		T <sub>J</sub> Decreasing			130		°C
Under Voltage Shutdown	UVLO	V <sub>IN</sub> Increasing		3.75	3.85	4.00	V
Under Voltage Shutdown Hysteresis					100		mV
Dynamic							
Turn On Time	t <sub>ON</sub>	$R_{L} = 500\Omega, C_{L} = 0.1\mu F$			1		ms
Turn Off Time	t <sub>OFF</sub>	$R_L = 500\Omega, C_L = 0.1\mu F$			0.1		ms
V <sub>OUT</sub> Rise Time	t <sub>R</sub>	$R_L = 500\Omega, C_L = 0.1\mu F$			3		ms
V <sub>OUT</sub> Fall Time	t <sub>F</sub>	$R_L = 500\Omega, C_L$	= 0.1µF		1.5		ms
Over Current Blanking Time	t <sub>BLANK</sub>	FPF2500, FPF2501, FPF2503, FPF2505		2.5	5	10	ms
Auto-Restart Time	t <sub>RESTART</sub>	FPF2500, FPF2	2503, FPF2505	320	640	1280	ms
Short Circuit Response Time		FPF2500, FPF2503, FPF2505 $V_{IN}$ = 12V, $V_{ON}$ = 5V Moderate Overcurrent Condition			3		μs

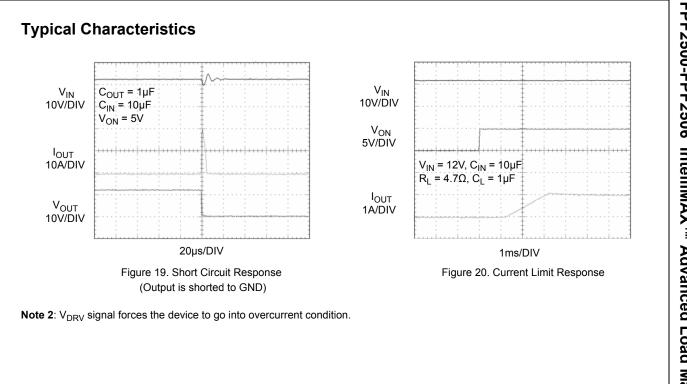
Note 1: Package power dissipation on 1 square inch pad, 2 oz. copper board.



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#### **Description of Operation**

The FPF2500 - FPF2506 are current limited switches that protect systems and loads which can be damaged or disrupted by the application of high currents. The core of each device is a 0.23 $\Omega$  N-channel MOSFET and a controller capable of functioning over a wide input operating range of 4.5 V -20 V. The controller protects against system malfunctions through current limiting under-voltage lockout and thermal shutdown. The current limit for FPF2500, FPF2501 and FPF2502 is adjustable from 500mA to 2A through the selection of an external resistor. The FPF2503 and FPF2504 the minimum current is internally fixed at 400 mA while that for the FPF2505 and FPF2506 is internally fixed at 800mA.

#### **On/Off Control**

The ON pin controls the state of the switch. When ON is high, the switch is in the on state. Activating ON continuously holds the switch in the on state so long as there is no fault. For all versions, an under-voltage on  $V_{\rm IN}$  or a junction temperature in excess of 140°C overrides the ON control to turn off the switch. In addition, excessive currents will cause the switch to turn off in the FPF2500, FPF2501, FPF2503 and FPF2505. The FPF2500, FPF2503 and FPF2505 have an Auto-Restart feature which will automatically turn the switch on again after 640ms. For the FPF2501, the ON pin must be toggled to turn-on the switch again. The FPF2502, FPF2504 and FPF2506 does not turn off in response to an over current condition but instead remains operating in a constant current mode so long as ON is active and the thermal shutdown or under-voltage lockout have not activated.

#### **Current Limiting**

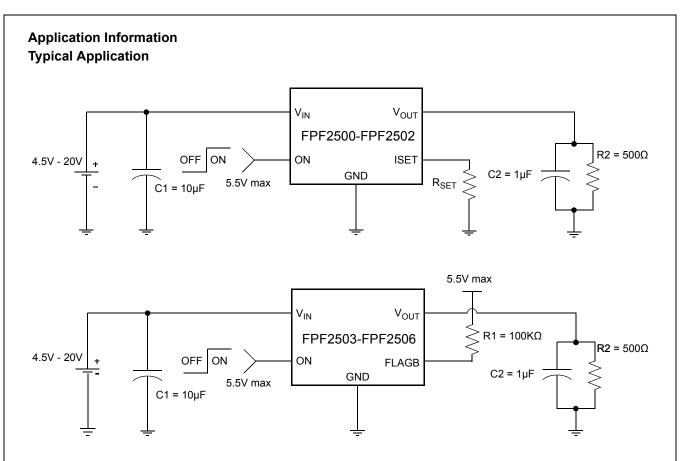
The current limit ensures that the current through the switch doesn't exceed a maximum value while not limiting at less than a minimum value. For the FPF2500. FPF2501 and FPF2502. the current at which the parts will limit is adjustable through the selection of an external resistor connected to ISET. Information for selecting the resistor is found in the Application Info section. For the FPF2503 and FPF2504 the minimum current is 400mA and the maximum current is 800mA and for the FPF2505-FPF2506 the minimum current is 800mA and the maximum current is 1600mA. The FPF2500, FPF2501, FPF2503 and FPF2505 have a blanking time of 5ms, nominally, during which the switch will act as a constant current source. At the end of the blanking time, the switch will be turned-off. For FPF2503 and FPF2505, at the end of the blanking time, the switch will be turned-off and the FLAGB pin will activate to indicate that current limiting has occurred. The FPF2502, FPF2504 and FPF2506 have no current limit blanking period so they will remain in a constant current state. For FPF2504 and FPF2506. immediately upon a current limit condition FLAGB is activated. The FPF2502, FPF2504 and FPF2506 devices will remain in constant current state until the ON pin is cycled or the thermal shutdown turns-off the switch.

#### **Under-Voltage Lockout**

The under-voltage lockout turns-off the switch if the input voltage drops below the under-voltage lockout threshold. With the ON pin active, the input voltage rising above the under-voltage lockout threshold will cause a controlled turn-on of the switch which limits current over-shoots.

#### **Thermal Shutdown**

The thermal shutdown protects the die from internally or externally generated excessive temperatures. During an overtemperature condition the switch is turned-off. The switch automatically turns-on again if the temperature of the die drops below the threshold temperature.



#### **Setting Current Limit**

The FPF2500, FPF2501, and FPF2502 have a current limit which is set with an external resistor connected between  $\rm I_{SET}$  and GND. This resistor is selected by using the following equation,

$$R_{SET} = 12500 \times I_{SET} \times e^{(0.485 \times I_{SET})}$$
 (1)

 $\mathsf{R}_{\mathsf{SET}}$  is in Ohms and  $\mathsf{I}_{\mathsf{SET}}$  is in Amps

The following table can also be used to select  $R_{SET}$ . A typical application would be the 0.500A current that is required by a single USB port. Using the table below an appropriate selection for the  $R_{SET}$  resistor would be 12.4K $\Omega$ . This will ensure that the port load could draw 0.525A, but not more than 0.875A. Likewise for a dual port system, an  $R_{SET}$  of 34.8K $\Omega$  would always deliver at least 1.050A and never more than 1.750A.

#### **Input Capacitor**

To limit the voltage drop on the input supply caused by transient in-rush currents when the switch turns-on into a discharged load capacitor or a short-circuit, a capacitor needs to be placed between V<sub>IN</sub> and GND. A 0.1µF ceramic capacitor, C<sub>IN</sub>, must be placed close to the V<sub>IN</sub> pin. A higher value of C<sub>IN</sub> can be used to further reduce the voltage drop experienced as the switch is turned on into a large capacitive load.

#### Current Limit Various R<sub>SET</sub> Values

		ISEL Faidee	
R <sub>SET</sub> [ΚΩ]	Min. Current Limit [A]	Typ. Current Limit [A]	Max. Current Limit [A]
7.87	0.375	0.500	0.625
10.0	0.450	0.600	0.750
12.4	0.525	0.700	0.875
14.7	0.600	0.800	1.000
17.4	0.675	0.900	1.125
20.5	0.750	1.000	1.250
23.2	0.825	1.100	1.375
26.7	0.900	1.200	1.500
30.9	0.975	1.300	1.625
34.8	1.050	1.400	1.750
39.0	1.125	1.500	1.875
43.2	1.200	1.600	2.000
48.7	1.275	1.700	2.125
53.6	1.350	1.800	2.250
59.6	1.425	1.900	2.375
64.9	1.500	2.000	2.500

#### **Output Capacitor**

A 0.1 $\mu F$  capacitor  $C_{OUT,}$  should be placed between  $V_{OUT}$  and GND. This capacitor will prevent parasitic board inductances from forcing V<sub>OUT</sub> below GND when the switch turns-off. For the FPF2501, FPF2503 and FPF2505, the total output capacitance needs to be kept below a maximum value,  $C_{\mbox{OUT}(\mbox{max})}$  to prevent the part from registering an over-current condition and turning off the switch. The maximum output capacitance can be determined from the following formula,

$$C_{OUT}(max) = \frac{I_{LIM}(min) \times t_{BLANK}(min)}{V_{IN}}$$
(2)

#### **Power Dissipation**

Due to the wide input voltage range that the parts can accept and the high currents at which the current limit can be set, care must be taken to prevent excessive power dissipation in the part from interrupting the switching of power to a load. During normal operation as a switch, the power dissipated in the part will depend upon the level at which the current limit is set. For a 0.5A typical load, the power dissipated will typically be,

$$P = (I_{LIM})^2 \times R_{DS} = (0.5)^2 \times 0.23 = 58 \text{mW}$$
(3)

This is well within the thermal capability of the package. The maximum allowed setting for the current limit is 2A and this will result in a power dissipation of typically,

$$P = (I_{LIM})^2 \times R_{DS} = (2)^2 \times 0.23 = 920 \text{mW}$$
 (4)

This is beyond the normal thermal capability of the package, but the thermal shutdown within the part will prevent damage by turning off the switch once the maximum junction temperature has been reached. If the part goes into current limit the maximum power dissipation will occur when the output is shorted to ground. For the FPF2500, FPF2503 and FPF2505 the power dissipation will scale by the Auto-Restart Time,  $t_{\mbox{\scriptsize RESTART}}$  and the Over Current Blanking Time,  $t_{\mbox{\scriptsize BLANK}}$  , so that the maximum power dissipated is,

$$P(max) = \frac{t_{BLANK}}{t_{RESTART} + t_{BLANK}} \times V_{IN}(max) \times I_{LIM}(max)$$
$$= \frac{5}{5} \times 20 \times 2.5 = 388 \text{mW}$$
(5)

$$5 + 640$$
  
This is more power than the package can dissipate, but the thermal shutdown of the part will activate to protect the part from damage due to excessive heating. The junction temperature will only be able to increase to the thermal shutdown threshold. Once this temperature has been reached, toggling ON will not

or Or turn-on the switch until the junction temperature drops. For the FPF2502, FPF2504 and FPF2506, a short on the output will cause the part to operate in a constant current state dissipating a worst case power of,

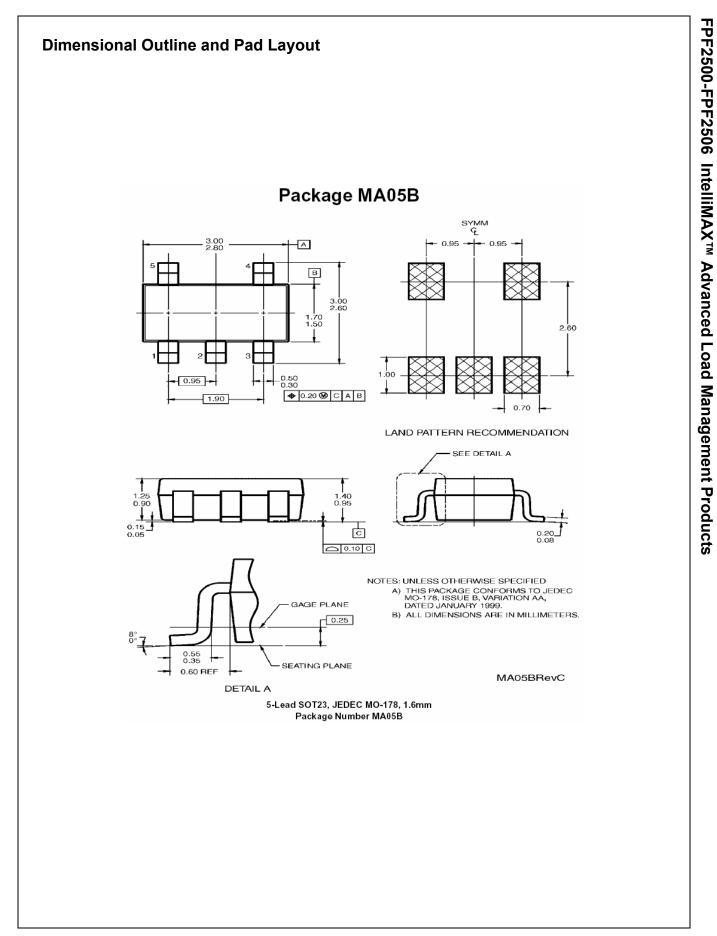
$$P(max) = V_{IN}(max) \times I_{LIM}(max)$$
$$= 20 \times 2.5 = 50W$$
(6)

This large amount of power will activate the thermal shutdown and the part will cycle in and out of thermal shutdown so long as the ON pin is active and the short is present.

#### **Board Layout**

For best performance, all traces should be as short as possible. To be most effective, the input and output capacitors should be placed close to the device to minimize the effects that parasitic trace inductances may have on normal and short-circuit operation. Using wide traces for  $V_{IN}$ ,  $V_{OUT}$  and GND will help minimize parasitic electrical effects along with minimizing the case to ambient thermal impedance.

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